STL4LN80K5



N-channel 800 V, 2.1 Ω typ., 3 A MDmesh™ K5 Power MOSFET in a PowerFLAT™ 5x6 VHV package

Datasheet - preliminary data

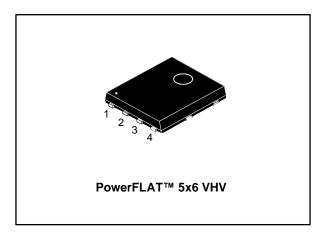
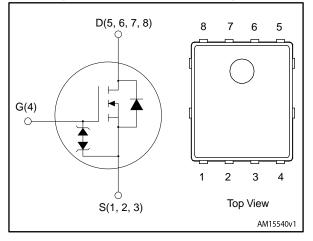


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D
STL4LN80K5	800 V	2.6 Ω	3 A

- Industry's lowest R_{DS(on)} * area
- Industry's best FoM (figure of merit)
- Ultra low-gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STL4LN80K5	4LN80K5	PowerFLAT™ 5x6 VHV	Tape and reel

Contents STL4LN80K5

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STL4LN80K5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V_{GS}	Gate-source voltage	± 30	V	
I _D	Drain current (continuous) at T _C = 25 °C	3	Α	
I _D	Drain current (continuous) at T _C = 100 °C	1.9	Α	
I _{DM} ⁽¹⁾	Drain current (pulsed)	12	Α	
P _{TOT}	Total dissipation at T _C = 25 °C	38	W	
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns	
dv/dt (3)	MOSFET dv/dt ruggedness	50		
T _j	Operating junction temperature	55 to 150	°C	
T _{stg}	Storage temperature	- 55 to 150		

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit	
R _{thj-case}	Thermal resistance junction-case	3.3	°C/W	
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	59	°C/W	

Notes

Table 4: Avalanche characteristics

Symbol	Symbol Parameter		Unit
I _{AR}	I _{AR} Avalanche current, repetitive or not repetitive (pulse width limited by Tjmax)		Α
E _{AS}	E_{AS} Single pulse avalanche energy (starting Tj = 25 °C, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$)		mJ

 $^{^{(1)}}$ Pulse width limited by safe operating area

 $^{^{(2)}}I_{SD} \leq 3$ A, dv/dt \leq 100 A/ μ s; V $_{DS}$ peak < V $_{(BR)DSS}$

 $^{^{(3)}}V_{DS} \le 640 \text{ V}$

 $^{^{(1)}}$ When mounted on FR-4 board of 1 inch², 2 oz Cu

Electrical characteristics STL4LN80K5

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_{D} = 1 \text{ mA}$	800			V
		$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$			1	μΑ
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ $T_{C} = 125 \text{ °C}$			50	μΑ
I _{GSS}	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 100 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 1.2 A		2.1	2.6	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	110	ı	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V, f} = 1 \text{ MHz, V}_{GS} = 0 \text{ V}$	-	9.5	ı	pF
C _{rss}	Reverse transfer capacitance	$V_{DS} = 100 \text{ V}, T = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$	-	0.4	ı	pF
Coss(eq) ⁽¹⁾	Equivalent output capacitance	$V_{DS} = 0$ to 640 V, $V_{GS} = 0$ V	-	TBD	1	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	1	18	ı	Ω
Q_g	Total gate charge	V _{DD} = 640 V, I _D = 2 A	-	4	-	nC
Q_gs	Gate-source charge	V _{GS} = 10 V,	-	TBD	-	nC
Q_{gd}	Gate-drain charge	see Figure 3: "Gate charge test circuit"	-	TBD	-	nC

Notes:

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V_{DD} = 400 V, I_{D} = 1.6 A, R_{G} = 4.7 Ω	-	TBD	-	ns
t _r	Rise time	$V_{GS} = 10 \text{ V}$	-	TBD	-	ns
t _{d(off)}	Turn-off delay time	(See Figure 2: "Switching times test circuit for resistive load"and Figure 7: "Switching time waveform")	1	TBD	1	ns
t _f	Fall time		ı	TBD	-	ns

 $^{^{(1)}}C_{oss\ eq}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		3	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		12	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 3 \text{ A}, V_{GS} = 0 \text{ V}$	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 3 A, di/dt = 100 A/μs,	-	TBD		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V, (see Figure 4: "Test circuit for inductive load switching and diode recovery times")	-	TBD		μC
I _{RRM}	Reverse recovery current		-	TBD		Α
t _{rr}	Reverse recovery time	I _{SD} = 3 A, di/dt = 100 A/μs,	-	TBD		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V, T _j = 150 °C (Figure 4: "Test circuit for inductive load switching and diode recovery times")	-	TBD		μC
I _{RRM}	Reverse recovery current		-	TBD		Α

Notes:

Table 9: Gate source-Zener diode

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit.
$V_{(BR)GS0}$	Gate-source breakdown voltage	I_{GS} = ± 1mA, I_{D} = 0 A	30	-	-	V

The built-in back-to-back Zener diodes have specifically been designed to enhance the device's ESD capability. In this respect the Zener voltage is appropriate to achieve an efficient and cost-effective intervention to protect the device's integrity. These integrated Zener diodes thus avoid the usage of external components.

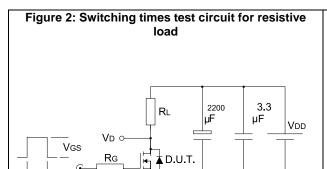
⁽¹⁾Pulse width limited by safe operating area

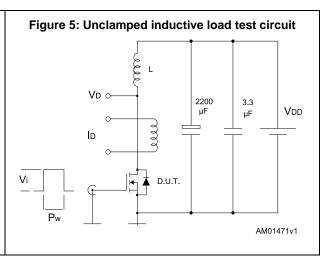
⁽²⁾Pulsed: pulse duration = 300 µs, duty cycle 1.5%

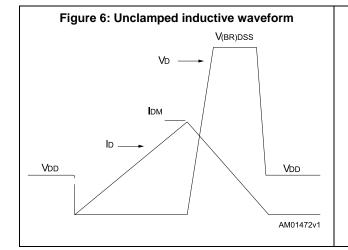
Test circuits STL4LN80K5

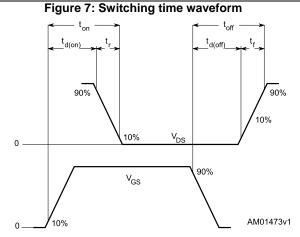
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3 Test circuits









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STL4LN80K5 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 PowerFLAT™ 5x6 VHV package information

Figure 8: PowerFLAT™ 5x6 VHV Package outline

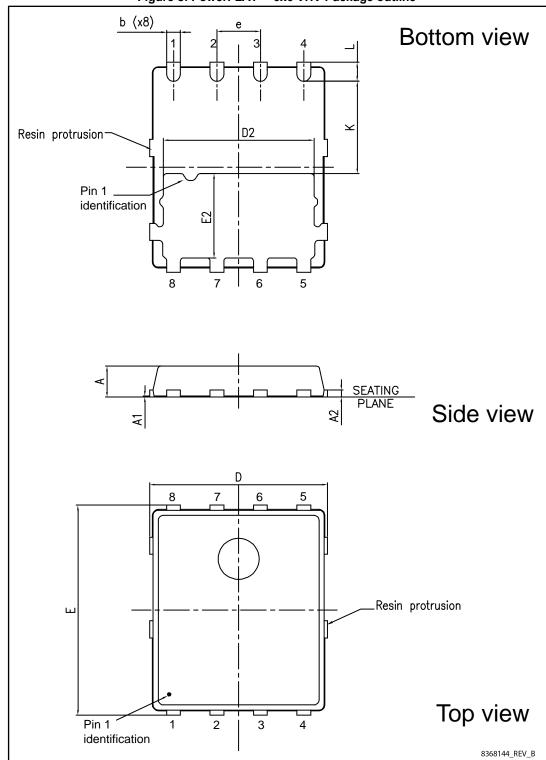
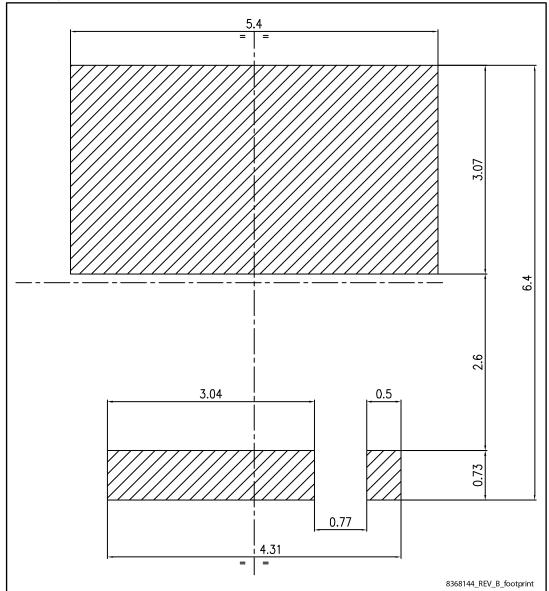


Table 10: PowerFLAT™ 5x6 VHV package mechanical data

Dim	mm				
Dim.	Min.	Тур.	Max.		
A	0.80		1.00		
A1	0.02		0.05		
A2		0.25			
b	0.30		0.50		
D	5.00	5.20	5.40		
E	5.95	6.15	6.35		
D2	4.30	4.40	4.50		
E2	2.40	2.50	2.60		
е		1.27			
L	0.50	0.55	0.60		
K	2.60	2.70	2.80		





STL4LN80K5 Package information

4.2 PowerFLAT™ 5x6 packing information

Figure 10: PowerFLAT™ 5x6 tape (dimensions are in mm)

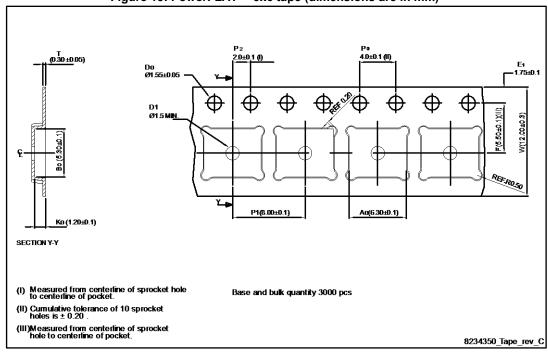


Figure 11: PowerFLAT™ 5x6 package orientation in carrier tape

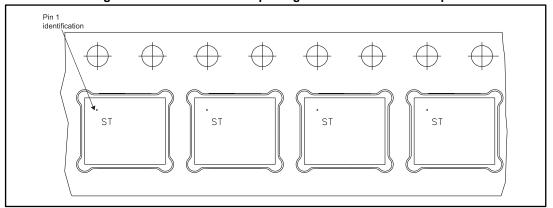


Figure 12: PowerFLAT™ 5x6 reel PART NO. A 330 (+0/-4.0) ESD LOGO All dimensions are in millimeters CORE DETAIL 8234350_Reel_rev_C

DocID027815 Rev 1

STL4LN80K5 Revision history

5 Revision history

Table 11: Document revision history

Date	Revision	Changes
29-May-2015	1	First release.

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